



National Cheng Kung University Inaugurates the Chi Duan Building Donated by Dr. Biing-Seng Wu, Chairman of Himax Technologies, Inc.

TAINAN, Taiwan – November 09, 2022 – Himax Technologies, Inc. (Nasdaq: HIMX) (“Himax” or “Company”), a leading supplier and fabless manufacturer of display drivers and other semiconductor products, today announced the National Cheng Kung University (“NCKU”), located in Tainan, Taiwan, inaugurated its new “Chi Duan Building” on November 9th, which was donated by Dr. Biing-Seng Wu, Chairman of Himax.

The Chi Duan Building is located on the Zih-Ciang Campus of NCKU, adjacent to the Electrical Engineering Department and the Chemical Engineering Department. Dr. Biing-Seng Wu donated over NT\$100 million (US\$3.14 million) to build the Chi Duan Building in 2016 and became the youngest alumnus to make a major donation in the school’s history. The university is best known for engineering, computer science, medicine, and planning and design. Dr. Biing-Seng Wu anticipates the Chi-Duan Building will serve as an important hub for industry-academia cooperation and talent cultivation.

“This new building represents my strong desire to give back to NCKU, where I spent most of my academic years, from undergraduate to master and PhD,” said Dr. Biing-Seng Wu. “The building is named after my parents, taking one character from each of their names. The underlying philosophy of ‘Chi’ is to inspire and elevate, whereas ‘Duan’ is to reform and authenticate. With those spirits, I believe we can plant the seeds of technological advancement and humane awareness into the youth of Taiwan. Despite the challenges encountered during the construction of the building, I am thankful and honored at its successful completion,” concluded Dr. Biing-Seng Wu.

A number of Himax's cutting-edge display products were exhibited at the inauguration ceremony. The ceremony was attended by Su Huey-Jen, President of NCKU, Chung Pau-Choo, Dean of the College of Electrical Engineering and Computer Science and Miin Wu School of Computing, Su Yan-Kuin, Dean of the Academy of Innovative Semiconductor and Sustainable Manufacturing, and Lin Chih-Lung, Chair of the Department of Electrical Engineering.

For the NCKU press release, please visit: <https://www.taiwannews.com.tw/en/news/4713511>

About Himax Technologies, Inc.

Himax Technologies, Inc. (NASDAQ: HIMX) is a fabless semiconductor solution provider dedicated to display imaging processing technologies. Himax is a worldwide market leader in display driver ICs and timing controllers used in TVs, laptops, monitors, mobile phones, tablets, automotive, digital cameras, car navigation, virtual reality (VR) devices and many other consumer electronics devices. Additionally, Himax designs and provides controllers for touch sensor displays, in-cell Touch and Display Driver Integration (TDDI) single-chip solutions, AMOLED ICs, LED driver ICs, power management ICs and LCoS micro-displays for augmented reality (AR) devices and heads-up displays (HUD) for automotive. The Company also offers CMOS image sensors, wafer level optics for AR devices, 3D sensing and ultralow power WiseEye™ AI image sensing, which are used in a wide variety of applications such as mobile phone, tablet, laptop, TV, PC camera, automobile, security, medical device, home appliance, AIoT, etc. Founded in 2001 and headquartered in Tainan, Taiwan, Himax currently employs around 2,100 people from three Taiwan-based offices in Tainan, Hsinchu and Taipei and country offices in China, Korea, Japan, German, and the US. Himax has 2,980 patents granted and 417 patents pending approval worldwide as of September 30, 2022. Himax has retained its position as the leading display imaging processing semiconductor solution provider to consumer electronics brands worldwide.

<https://www.himax.com.tw>

Forward Looking Statements

Factors that could cause actual events or results to differ materially from those described in this conference call include, but are not limited to, the effect of the Covid-19 pandemic on the Company's business; general business and economic conditions and the state of the semiconductor industry; market acceptance and competitiveness of the driver and non-driver products developed by the Company; demand for end-use applications products; reliance on a small group of principal customers; the uncertainty of continued success in technological innovations; our ability to develop and protect our intellectual property; pricing pressures including declines in average selling prices; changes in customer order patterns; changes in estimated full-year effective tax rate; shortage in supply of key components; changes in environmental laws and regulations; changes in export license regulated by Export Administration Regulations (EAR); exchange rate fluctuations; regulatory approvals for further investments in our subsidiaries; our ability to collect accounts receivable and manage inventory and other risks described from time to time in the Company's SEC filings, including those risks identified in the section entitled "Risk Factors" in its Form 20-F for the year ended December 31, 2021 filed with the SEC, as may be amended.

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